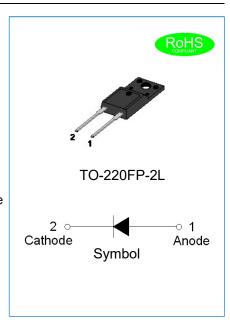
## JIEJIE MICROELECTRONICS CO., LTD.

# JECR2006FPL EPI HYPERFAST RECOVERY RECTIFIER

Rev.1.3

#### **DESCRIPTION**

- Plastic package has underwriters laboratory flammability classification 94V-0
- ♦ Lead free in comply with EU RoHS 2011/65/EU directives
- ♦ Low reverse leakage current
- ♦ Hyperfast recovery time and soft recovery characteristics
- ♦ Low recovery loss
- Applications for continuous current mode (CCM) power factor correction (PFC),active PFC in air conditioner, half-bridge/full-bridge switched-mode power supplies



#### **MECHANICAL DATA**

♦ Case: TO-220FP-2L molded plastic over passivated junction

→ Terminals: Solder plated, solderable per J-STD-002

♦ Weight: 2gram

#### ABSOLUTE MAXIMUM RATING (Rating at 25℃ ambient temperature unless otherwise specified.)

Parameter	Symbol	JECR2006FPL	Unit
Maximum repetitive peak reverse voltage	$V_{RRM}$	600	\ \
Maximum RMS voltage	V <sub>RMS</sub>	420	\ \
Maximum DC blocking voltage	V <sub>DC</sub>	600	٧
Average forward current at T <sub>h</sub> ≤51 °C	I <sub>F(AV)</sub>	20	Α
Peak forward surge current: 10ms single half sine-wave superimposed on rated load		200	_
Peak forward surge current: 8.3ms single half sine-wave superimposed on rated load	<b>I</b> FSM	220	A
Junction temperature and storage temperature range	$T_{j}, T_{stg}$	-55 to +150	$^{\circ}\!\mathbb{C}$

#### **ISOLATION CHARACTERISTICS**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
		50Hz≤f≤60Hz,RH≤65%,				
V	DMC inclotion voltage	from all pins to external			2500	\/
$V_{isol(RMS)}$	RMS isolation voltage	heatsink, sinusoidal waveform,	-	-		V
		clean and dust free				
0	Isolation capacitance	from cathode to external	-	40		٦
C <sub>isol</sub>		heatsink		10	-	pF



### **ELECTRICAL CHARACTERISTICS**(Rating at $25^{\circ}$ C ambient temperature unless otherwise specified.)

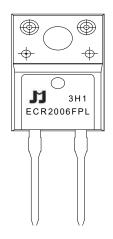
Parame	Symbol	Min.	Тур.	Max.	Unit	
	I <sub>F</sub> =20A,T <sub>j</sub> =25℃	.,	-	1.8	2.5	.,
Forward voltage	I <sub>F</sub> =20A,T <sub>j</sub> =150°C	V <sub>F</sub>	-	1.2	1.6	V
DC reverse current	T <sub>j</sub> =25℃		-	-	5	
at rated DC blocking voltage	T <sub>j</sub> =150℃	l <sub>R</sub>	-	-	300	μΑ
	I <sub>F</sub> =1A,V <sub>R</sub> =30V, di/dt=50A/µs,T <sub>i</sub> =25℃	-	-	35		
Reverse recovery time	$I_F$ =20A, $V_R$ =200V, di/dt=200A/ $\mu$ s, $T_j$ =25°C	t <sub>rr</sub>	-	32	-	ns
	I <sub>F</sub> =20A,V <sub>R</sub> =200V, di/dt=200A/µs,T <sub>j</sub> =125℃		1	55	-	
Dock roverse recovery ourrent	I <sub>F</sub> =20A,V <sub>R</sub> =200V, di/dt=200A/µs,T <sub>j</sub> =25℃		-	2.9	-	_
Peak reverse recovery current	I <sub>F</sub> =20A,V <sub>R</sub> =200V, di/dt=200A/µs,T <sub>j</sub> =125℃	l <sub>RM</sub>	-	8	-	Α
D	I <sub>F</sub> =20A,V <sub>R</sub> =200V, di/dt=200A/μs,T <sub>j</sub> =25°C	_	-	50	-	
Recovered charge	I <sub>F</sub> =20A,V <sub>R</sub> =200V, di/dt=200A/µs,T <sub>j</sub> =125°C	Qr	-	220	-	nC

#### THERMAL RESISTANCES

Symbol	Parameter	Min.	Тур.	Max.	Unit
$R_{th(j-h)}$	Thermal resistance from junction to heatsink	-	-	3.5	℃W
$R_{\text{th(j-a)}}$	Thermal resistance from junction to ambient	-	55	1	°C/W



#### **MARKING**



ECR	EPI Hyperfast Recovery Rectifier
20	I <sub>F(AV)</sub> =20A
06	V <sub>RRM</sub> :600V
FPL	Package:TO-220FP-2L

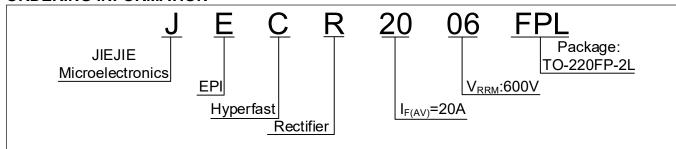
<u>x</u>H1: Month, 1/2/3~9/A/B/C

3**x**1:

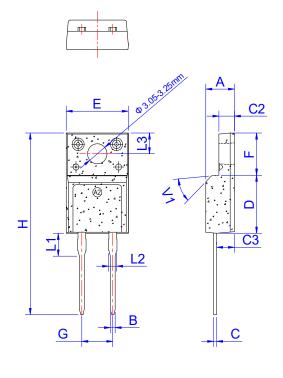
_						
2018	2019	2020	2021	2022	2023	2024
Н	I	J	K	L	М	N
2025	2026	2027	2028	2029	2030	
0	Р	Q	R	S	Т	

3Hx: Batch number

#### **ORDERING INFORMATION**



#### **PACKAGE MECHANICAL DATA**

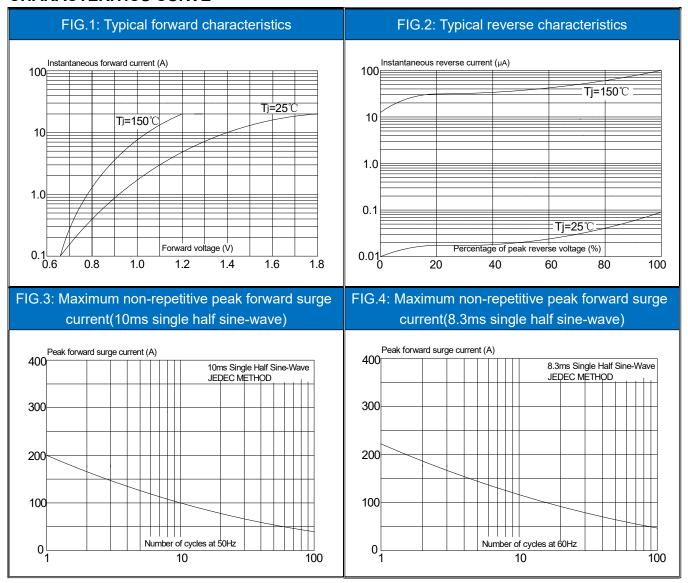


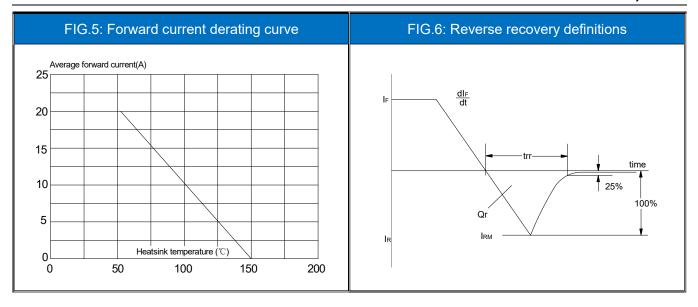
	Dimensions					
Ref.		Millimeters			Inches	
	Min.	Тур.	Max.	Min.	Тур.	Max.
Α	4.50		4.90	0.177		0.193
В	0.74	0.80	0.83	0.029	0.031	0.033
С	0.47		0.65	0.019		0.026
C2	2.45		2.75	0.096		0.108
C3	2.60		3.00	0.102		0.118
D	8.80		9.30	0.346		0.366
Е	9.80		10.4	0.386		0.410
F	6.40		6.80	0.252		0.268
G		5.08			0.200	
Н	28.0		29.8	1.102		1.173
L1		3.63			0.143	
L2	1.14		1.70	0.045		0.067
L3		3.30			0.130	
V1		45°			45°	

#### PACKAGE INFORMATION-TO-220FP-2L

OUTLINE	UNIT WEIGHT	TUBE	PER CARTON
	(g/PCS) TYP	(PCS)	(PCS)
TUBE	2	50	5,000

#### **CHARACTERITICS CURVE**





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